

### ANY-RATE PRECISION CLOCK MULTIPLIER/JITTER ATTENUATOR

### **Description**

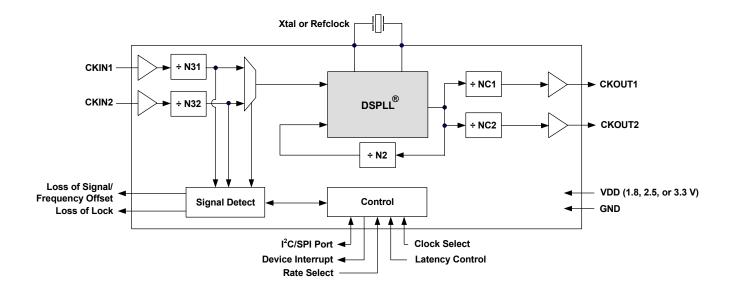
The Si5326 is a litter-attenuating precision clock multiplier for applications requiring sub 1 ps jitter performance. The Si5326 accepts dual clock inputs ranging from 2 kHz to 710 MHz and generates two clock outputs ranging from 2 kHz to 945 MHz and select frequencies to 1.4 GHz. The two outputs are divided down separately from a common source. The device provides virtually any frequency translation combination across this operating range. The Si5326 input clock frequency and clock multiplication ratio are programmable through an I<sup>2</sup>C or SPI interface. The Si5326 is based on Silicon Laboratories' 3rd-generation DSPLL® technology. which provides any-rate frequency synthesis and jitter attenuation in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The DSPLL loop bandwidth is digitally programmable, providing jitter performance optimization at the application level. Operating from a single 1.8, 2.5, or 3.3 V supply, the Si5326 is ideal for providing clock multiplication and jitter attenuation in high performance timing applications.

### **Applications**

- SONET/SDH OC-48/OC-192 line cards
- GbE/10GbE, 1/2/4/8/10GFC line cards
- ITU G.709 and custom FEC line cards
- Optical modules
- Wireless basestations
- Data converter clocking
- xDSL
- SONET/SDH + PDH clock synthesis
- Test and measurement

#### **Features**

- Generates any frequency from 2 kHz to 945 MHz and select frequencies to 1.4 GHz from an input frequency of 2 kHz to 710 MHz
- Ultra-low jitter clock outputs w/jitter generation as low as 0.3 ps rms (50 kHz–80 MHz)
- Integrated loop filter with selectable loop bandwidth (60 Hz to 8.4 kHz)
- Meets OC-192 GR-253-CORE jitter specifications
- Dual clock inputs w/manual or automatically controlled hitless switching
- Dual clock outputs with selectable signal format (LVPECL, LVDS, CML, CMOS)
- Support for ITU G.709 and custom FEC ratios (255/238, 255/237, 255/236)
- LOL, LOS, FOS alarm outputs
- Digitally-controlled output phase adjust
- I<sup>2</sup>C or SPI programmable
- On-chip voltage regulator for 1.8, 2.5, or 3.3 V ±10% operation
- Small size: 6 x 6 mm 36-lead QFN
- Pb-free, ROHS compliant



**Table 1. Performance Specifications** 

 $(V_{DD} = 1.8, 2.5, \text{ or } 3.3 \text{ V } \pm 10\%, T_A = -40 \text{ to } 85 \text{ °C})$ 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Temperature Range	T <sub>A</sub>		-40	25	85	°C
Supply Voltage	V <sub>DD</sub>		2.97	3.3	3.63	V
			2.25	2.5	2.75	V
			1.62	1.8	1.98	V
Supply Current	I <sub>DD</sub>	f <sub>OUT</sub> = 622.08 MHz Both CKOUTs enabled LVPECL format output	_	251	279	mA
		CKOUT2 disabled	_	217	243	mA
		f <sub>OUT</sub> = 19.44 MHz Both CKOUTs enabled CMOS format output	_	204	234	mA
		CKOUT2 disabled	_	194	220	mA
		Tristate/Sleep Mode	_	TBD	TBD	mA
Input Clock Frequency (CKIN1, CKIN2)	CK <sub>F</sub>	Input frequency and clock multiplication ratio deter-	0.002	_	710	MHz
Output Clock Frequency (CKOUT1, CKOUT2)	CK <sub>OF</sub>	mined by programming device PLL dividers. Consult Silicon Laboratories configuration software DSPLLsim to determine PLL divider settings for a given input frequency/clock multiplication ratio combination.	0.002 970 1213	_	945 1134 1417	MHz
Input Clocks (CKIN1, CK	IN2)		<u>l</u>			
Differential Voltage Swing	CKN <sub>DPP</sub>		0.25	_	1.9	VPP
Common Mode Voltage	CKN <sub>VCM</sub>	1.8 V ±10%	0.9	_	1.4	V
		2.5 V ±10%	1.0	_	1.7	V
		3.3 V ±10%	1.1	_	1.95	V
Rise/Fall Time	CKN <sub>TRF</sub>	20–80%	_	_	11	ns
Duty Cycle	CKN <sub>DC</sub>	Whichever is less	40	_	60	%
			50	_	_	ns
Output Clocks (CKOUT1,	CKOUT2)		<u>'</u>		•	
Common Mode	V <sub>OCM</sub>	LVPECL	V <sub>DD</sub> – 1.42	_	V <sub>DD</sub> – 1.25	V
Differential Output Swing	V <sub>OD</sub>	100 Ω load	1.1	_	1.9	
Single Ended Output Swing	$V_{SE}$	- line-to-line	0.5	_	0.93	٧
Rise/Fall Time	CKO <sub>TRF</sub>	20–80%		230	350	ps

**Note:** For a more comprehensive listing of device specifications, please consult the Silicon Laboratories Any-Rate Precision Clock Family Reference Manual. This document can be downloaded from <a href="https://www.silabs.com/timing">www.silabs.com/timing</a>.



**Table 1. Performance Specifications (Continued)** 

 $(V_{DD} = 1.8, 2.5, or 3.3 V \pm 10\%, T_A = -40 to 85 °C)$ 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Duty Cycle	CKO <sub>DC</sub>		45	_	55	%
PLL Performance						•
Jitter Generation	J <sub>GEN</sub>	f <sub>OUT</sub> = 622.08 MHz, LVPECL output format 50 kHz–80 MHz	_	0.3	TBD	ps rms
		12 kHz–20 MHz	_	0.3	TBD	ps rms
		800 Hz-80 MHz	_	TBD	TBD	ps rms
Jitter Transfer	J <sub>PK</sub>			0.05	0.1	dB
External Reference Jitter Transfer	J <sub>PKEXTN</sub>		_	TBD	TBD	dB
Phase Noise	CKO <sub>PN</sub>	f <sub>OUT</sub> = 622.08 MHz 100 Hz offset	_	TBD	TBD	dBc/Hz
		1 kHz offset	_	TBD	TBD	dBc/Hz
		10 kHz offset	_	TBD	TBD	dBc/Hz
		100 kHz offset	_	TBD	TBD	dBc/Hz
		1 MHz offset	_	TBD	TBD	dBc/Hz
Subharmonic Noise	SP <sub>SUBH</sub>	Phase Noise @ 100 kHz Off- set	_	TBD	TBD	dBc
Spurious Noise	SP <sub>SPUR</sub>	Max spur @ n x F3 (n ≥ 1, n x F3 < 100 MHz)	_	TBD	TBD	dBc
Package		,		•		•
Thermal Resistance Junction to Ambient	Theta JA	Still Air	_	TBD	_	°C/W

**Note:** For a more comprehensive listing of device specifications, please consult the Silicon Laboratories Any-Rate Precision Clock Family Reference Manual. This document can be downloaded from <a href="https://www.silabs.com/timing">www.silabs.com/timing</a>.

**Table 2. Absolute Maximum Ratings** 

Parameter	Symbol	Value	Unit
DC Supply Voltage	$V_{DD}$	-0.5 to 3.6	V
LVCMOS Input Voltage	$V_{DIG}$	-0.3 to (V <sub>DD</sub> + 0.3)	V
Operating Junction Temperature	T <sub>JCT</sub>	-55 to 150	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
ESD HBM Tolerance (100 pF, 1.5 kΩ)		2	kV
ESD MM Tolerance		200	V
Latch-Up Tolerance		JESD78 Compliant	

**Note:** Permanent device damage may occur if the Absolute Maximum Ratings are exceeded. Functional operation should be restricted to the conditions as specified in the operation sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods of time may affect device reliability.



### 155.52 MHz in, 622.08 MHz out

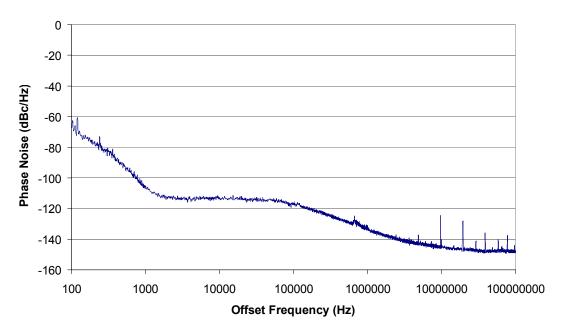
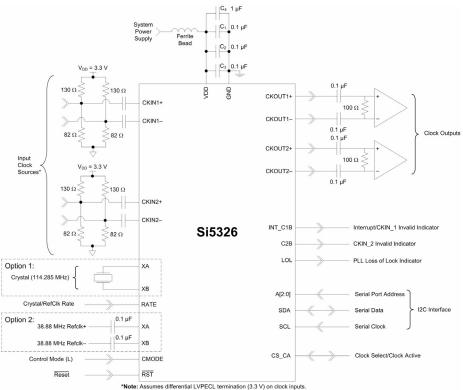


Figure 1. Typical Phase Noise Plot



\*Note: Assumes differential LVPECL termination (3.3 V) on clock inputs.

Figure 2. Si5326 Typical Application Circuit (I<sup>2</sup>C Control Mode)

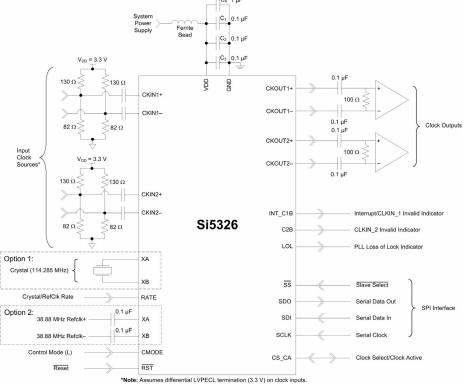


Figure 3. Si5326 Typical Application Circuit (SPI Control Mode)



### 1. Functional Description

The Si5326 is a jitter-attenuating precision clock multiplier for applications requiring sub 1 ps jitter performance. The Si5326 accepts dual clock inputs ranging from 2 kHz to 710 MHz and generates two independent, synchronous clock outputs ranging from 2 kHz to 945 MHz and select frequencies to 1.4 GHz. The device provides virtually any frequency translation combination across this operating range. Independent dividers are available for each input clock and output clock, so the Si5326 can accept input clocks at different frequencies and it can generate output clocks at different frequencies. The Si5326 input clock frequency and clock multiplication ratio are programmable through an I<sup>2</sup>C or SPI interface. Silicon Laboratories offers a PC-based software utility, DSPLLsim, that can be used to determine the optimum PLL divider settings for a input frequency/clock multiplication combination that minimizes phase noise and power consumption. This utility can be downloaded from www.silabs.com/timing.

The Si5326 is based on Silicon Laboratories' 3rd-generation DSPLL® technology, which provides anyrate frequency synthesis and jitter attenuation in a highly integrated PLL solution that eliminates the need for external VCXO and loop filter components. The Si5326 PLL loop bandwidth is digitally programmable and supports a range from 60 Hz to 8.4 kHz. The DSPLLsim software utility can be used to calculate valid loop bandwidth settings for a given input clock frequency/clock multiplication ratio.

The Si5326 supports hitless switching between the two input clocks in compliance with GR-253-CORE and GR-1244-CORE that greatly minimizes the propagation of phase transients to the clock outputs during an input clock transition (<200 ps typ). Manual and automatic revertive and non-revertive input clock switching options are available. The Si5326 monitors both input clocks for loss-of-signal and provides a LOS alarm when it detects missing pulses on either input clock. The device monitors the lock status of the PLL. The lock detect algorithm works by continuously monitoring the phase of the input clock in relation to the phase of the feedback clock. The Si5326 also monitors frequency offset alarms (FOS), which indicate if an input clock is within a specified frequency precision relative to the frequency of a reference clock. Both Stratum 3/3E and SONET Minimum Clock (SMC) FOS thresholds are supported.

The Si5326 provides a digital hold capability that allows the device to continue generation of a stable output clock when the selected input reference is lost. During digital hold, the DSPLL generates an output frequency based on a historical average frequency that existed a fixed amount of time before the error event occurred, eliminating the effects of phase and frequency transients that may occur immediately preceding digital hold.

Fine phase adjustment is available and is set using the <u>FLAT</u> register bits. The nominal range and resolution of the <u>FLAT</u>[14:0] latency adjustment word are: ±110 ps and 3.05 ps respectively.

The Si5326 has two differential clock outputs. The electrical format of each clock output is independently programmable to support LVPECL, LVDS, CML, or CMOS loads. If not required, the second clock output can be powered down to minimize power consumption. The phase difference between the selected input clock and the output clocks is adjustable in 200 ps increments for system skew control. In addition, the phase of one output clock may be adjusted in relation to the phase of the other output clock. The resolution varies from 800 ps to 2.2 ns depending on the PLL divider settings. Consult the DSPLLsim configuration software to determine the phase offset resolution for a given input clock/clock multiplication ratio combination. For systemlevel debugging, a bypass mode is available which drives the output clock directly from the input clock, bypassing the internal DSPLL. The device is powered by a single 1.8, 2.5, or 3.3 V supply.

#### 1.1. External Reference

An external, high quality 38.88 MHz clock or a low-cost 114.285 MHz 3rd overtone crystal is used as part of a fixed-frequency oscillator within the DSPLL. This external reference is required for the device to perform jitter attenuation. Silicon Laboratories recommends using a high-quality crystal from TXC (www.txc.com.tw), part number 7MA1400014. An external 38.88 MHz clock from a high quality OCXO or TCXO can also be used as a reference for the device.

In digital hold, the DSPLL remains locked to this external reference. Any changes in the frequency of this reference when the DSPLL is in digital hold will be tracked by the output of the device. Note that crystals can have temperature sensitivities.

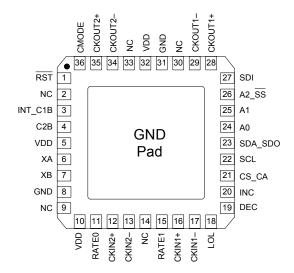
#### 1.2. Further Documentation

Consult the Silicon Laboratories Any-Rate Precision Clock Family Reference Manual (FRM) for more detailed information about the Si5326. The FRM can be downloaded from <a href="https://www.silabs.com/timing">www.silabs.com/timing</a>.

Silicon Laboratories has developed a PC-based software utility called DSPLLsim to simplify device configuration, including frequency planning and loop bandwidth selection. This utility can be downloaded from www.silabs.com/timing.



# 2. Pin Descriptions: Si5326



Pin numbers are preliminary and subject to change.

	I/O	Signal Level	Description
RST	I	LVCMOS	External Reset.
			Active low input that performs external hardware reset of device. Resets all internal logic to a known state and forces the device registers to their default value. Clock outputs are tristated during reset. After rising edge of RST signal, the Si5326 will perform an internal self-calibration. This pin has a weak pull-up.
NC	_	_	No Connect.
			This pin must be left unconnected for normal operation.
INT_C1B	0	LVCMOS	Interrupt/CKIN1 Invalid Indicator.
			This pin functions as a device interrupt output or an alarm output for CKIN1. If used as an interrupt output, <u>INT_PIN</u> must be set to 1. The pin functions as a maskable interrupt output with active polarity controlled by the <u>INT_POL</u> register bit. If used as an alarm output, the pin functions as a LOS (and optionally FOS) alarm indicator for CKIN1. Set <u>CK1_BAD_PIN</u> = 1 and <u>INT_PIN</u> = 0.
			0 = CKIN1 present.
			1 = LOS (FOS) on CKIN1.
			The active polarity is controlled by <u>CK_BAD_POL</u> . If no function is selected, the pin tristates.
	NT_C1B	NT_C1B O	

Pin #	Pin Name	I/O	Signal Level	Description
4	C2B	0	LVCMOS	CKIN2 Invalid Indicator.  This pin functions as a LOS (and optionally FOS) alarm indicator for CKIN2 if <u>CK2_BAD_PIN</u> = 1.  0 = CKIN2 present.  1 = LOS (FOS) on CKIN2.  The active polarity can be changed by <u>CK_BAD_POL</u> . If <u>CK2_BAD_PIN</u> = 0, the pin tristates.
5, 10, 32	V <sub>DD</sub>	V <sub>DD</sub>	Supply	Supply.  The device operates from a 1.8, 2.5, or 3.3 V supply. Bypass capacitors should be associated with the following Vdd pins:  5  0.1 μF  10  0.1 μF  32  0.1 μF  A 1.0 μF should be placed as close to the device as is practical.
7 6	XB XA	I	Analog	External Crystal or Reference Clock.  External crystal should be connected to these pins to use internal oscillator based reference. If external reference is used, apply reference clock to XA input and leave XB pin floating. External reference must be from a high-quality clock source (TCXO, OCXO). Frequency of crystal or external clock is set by RATE[1:0] pins.
8, 31	GND	GND	Supply	Ground.  Must be connected to system ground. Minimize the ground path impedance for optimal performance of this device.
11 15	RATE0 RATE1	I	3-Level	External Crystal or Reference Clock Rate.  Three level inputs that select the type and rate of external crystal or reference clock to be applied to the XA/XB port.  LM = 38.88 MHz external clocks  MM = 114.285 MHz 3rd OT crystal  HH = converts part to Si5325, and no external crystal or reference is needed
16 17	CKIN1+ CKIN1-	I	Multi	Clock Input 1.  Differential input clock. This input can also be driven with a single-ended signal. Input frequency range is 2 kHz to 710 MHz.
12 13	CKIN2+ CKIN2-	I	Multi	Clock Input 2.  Differential input clock. This input can also be driven with a single-ended signal. Input frequency range is 2 kHz to 710 MHz.
18	LOL	0	LVCMOS	PLL Loss of Lock Indicator.  This pin functions as the active high PLL loss of lock indicator if the LOL_PIN register bit is set to 1.  0 = PLL locked.  1 = PLL unlocked.  If LOL_PIN = 0, this pin will tristate. Active polarity is controlled by the LOL_POL bit. The PLL lock status will always be reflected in the LOL_INT read only register bit.  erlined italics, e.g. INT_PIN. See Si5326 Register Map.



Pin#	Pin Name	I/O	Signal Level	Description
19	DEC	I	LVCMOS	Latency Decrement.
				A pulse on this pin decreases the input to output device latency by 1/f <sub>OSC</sub> (approximately 200 ps). There is no limit on the range of latency adjustment by this method.  Pin control is enabled by setting <code>INCDEC_PIN</code> = 1. If <code>INCDEC_PIN</code> = 0, this pin is ignored and output latency is controlled via the <code>CLAT</code> register.  If both INC and DEC are tied high, phase buildout is disabled and the device maintains a fixed-phase relationship between the selected input clock and the output clock during an input clock switch.  This pin has a weak pull-down.
20	INC	I	LVCMOS	Latency Increment.
				A pulse on this pin increases the input to output device latency by 1/f <sub>OSC</sub> (approximately 200 ps). There is no limit on the range of latency adjustment by this method.  Pin control is enabled by setting <code>INCDEC_PIN</code> = 1. If <code>INCDEC_PIN</code> = 0, this pin is ignored and output latency is controlled via the <code>CLAT</code> register.  If both INC and DEC are tied high, phase buildout is disabled and the device maintains a fixed-phase relationship between the selected input clock and the output clock during an input clock switch.  This pin has a weak pull-down.
21	CS_CA	I/O	LVCMOS	Input Clock Select/Active Clock Indicator.
				In manual clock selection mode, this pin functions as the manual input clock selector if the <u>CKSEL_PIN</u> is set to 1.  0 = Select CKIN1.  1 = Select CKIN2.  If <u>CKSEL_PIN</u> = 0, the <u>CKSEL_REG</u> register bit controls this function and this input tristates.  In automatic clock selection mode, this pin indicates which of the two input clocks is currently the active clock. If alarms exist on both clocks, CK_ACTV will indicate the last active clock that was used before entering the digital hold state. The <u>CK_ACTV_PIN</u> register bit must be set to 1 to reflect the active clock status to the CK_ACTV output pin.  0 = CKIN1 active input clock.  1 = CKIN2 active input clock.  If <u>CK_ACTV_PIN</u> = 0, this pin will tristate. The CK_ACTV status will always be reflected in the <u>CK_ACTV_REG</u> read only register bit.  This pin has a weak pull-down.
22	SCL	I	LVCMOS	Serial Clock/Serial Clock.
				This pin functions as the serial clock input for both SPI and I <sup>2</sup> C modes.



Pin#	Pin Name	I/O	Signal Level	Description
23	SDA SDO	I/O	LVCMOS	Serial Data.
				In I <sup>2</sup> C control mode (CMODE = 0), this pin functions as the bidirectional serial data port.  In SPI control mode (CMODE = 1), this pin functions as the serial data output.
25 24	A1 A0	I	LVCMOS	Serial Port Address.  In I <sup>2</sup> C control mode (CMODE = 0), these pins function as hardware controlled address bits.  In SPI control mode (CMODE = 1), these pins are ignored.
26	A2_SS	I	LVCMOS	Serial Port Address/Slave Select.  In I <sup>2</sup> C control mode (CMODE = 0), this pin functions as a hardware controlled address bit.  In SPI control mode (CMODE = 1), this pin functions as the slave select input.
27	SDI	I	LVCMOS	Serial Data In.  In I <sup>2</sup> C control mode (CMODE = 0), this pin is ignored.  In SPI control mode (CMODE = 1), this pin functions as the serial data input.
29 28	CKOUT1- CKOUT1+	0	Multi	Output Clock 1.  Differential output clock with a frequency range of 10 MHz to 1.4175 GHz. Output signal format is selected by <u>SFOUT1_REG</u> register bits. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.
34 35	CKOUT2- CKOUT2+	0	Multi	Output Clock 2.  Differential output clock with a frequency range of 10 MHz to 1.4175 GHz. Output signal format is selected by <u>SFOUT2_REG</u> register bits. Output is differential for LVPECL, LVDS, and CML compatible modes. For CMOS format, both output pins drive identical single-ended clock outputs.
36	CMODE	I	LVCMOS	Control Mode.  Selects I <sup>2</sup> C or SPI control mode for the Si5326.  0 = I <sup>2</sup> C Control Mode  1 = SPI Control Mode
GND PAD	GND	GND	Supply	Ground Pad.  The ground pad must provide a low thermal and electrical impedance to a ground plane.



10

# 3. Ordering Guide

Ordering Part Number	Output Clock Frequency Range	Package	Temperature Range
Si5326A-B-GM	2 kHz–945 MHz 970–1134 MHz 1.213–1.417 GHz	36-Lead 6 x 6 mm QFN	–40 to 85 °C
Si5326B-B-GM	2 kHz-808 MHz	36-Lead 6 x 6 mm QFN	–40 to 85 °C
Si5326C-B-GM	2 kHz-346 MHz	36-Lead 6 x 6 mm QFN	–40 to 85 °C



## 4. Package Outline: 36-Pin QFN

Figure 4 illustrates the package details for the Si5326. Table 3 lists the values for the dimensions shown in the illustration.

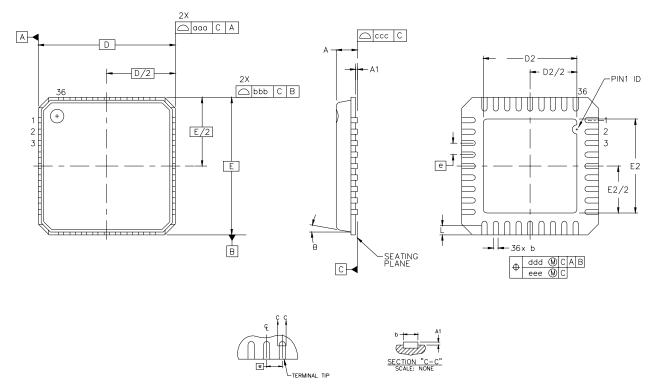


Figure 4. 36-Pin Quad Flat No-lead (QFN)

**Table 3. Package Dimensions** 

Symbol	Millimeters			
	Min	Nom	Max	
Α	0.80	0.85	0.90	
A1	0.00	0.01	0.05	
b	0.18	0.23	0.30	
D	6.00 BSC			
D2	3.95	4.10	4.25	
е	0.50 BSC			
E	6.00 BSC			
E2	3.95	4.10	4.25	

Symbol	Millimeters			
	Min	Nom	Max	
L	0.50	0.60	0.75	
θ	_	_	12°	
aaa	_	_	0.10	
bbb	_	_	0.10	
CCC	_	_	0.05	
ddd	_	_	0.10	
eee	_	_	0.05	

#### Notes:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
- 3. This drawing conforms to JEDEC outline MO-220, variation VJJD.
- **4.** Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.



# 5. Recommended PCB Layout

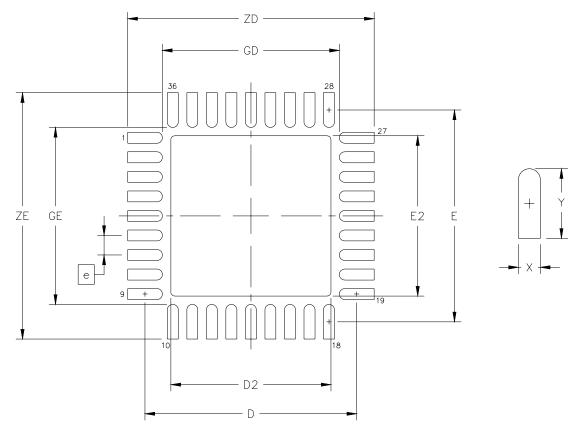


Figure 5. PCB Land Pattern Diagram

**Table 4. PCB Land Pattern Dimensions** 

Dimension	MIN	MAX
е	0.50 E	SSC.
Е	5.42 F	REF.
D	5.42 F	REF.
E2	4.00	4.20
D2	4.00	4.20
GE	4.53	_
GD	4.53	_
X	_	0.28
Y	0.89 F	REF.
ZE	_	6.31
ZD	_	6.31

#### Notes (General):

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
- 3. This Land Pattern Design is based on IPC-SM-782 guidelines.
- **4.** All dimensions shown are at Maximum Material Condition (MMC). Least Material Condition (LMC) is calculated based on a Fabrication Allowance of 0.05 mm.

#### Notes (Solder Mask Design):

1. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be  $60 \mu m$  minimum, all the way around the pad.

#### Notes (Stencil Design):

- 1. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 2. The stencil thickness should be 0.125 mm (5 mils).
- **3.** The ratio of stencil aperture to land pad size should be 1:1 for the perimeter pads.
- **4.** A 4 x 4 array of 0.80 mm square openings on 1.05 mm pitch should be used for the center ground pad.

#### Notes (Card Assembly):

- 1. A No-Clean, Type-3 solder paste is recommended.
- 2. The recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.



### **DOCUMENT CHANGE LIST**

### Revision 0.1 to Revision 0.2

- Updated LVTTL to LVCMOS is Table 2, "Absolute Maximum Ratings," on page 3.
- Added Figure 1, "Typical Phase Noise Plot," on page 4.
- Updated Figure 2, "Si5326 Typical Application Circuit (I<sup>2</sup>C Control Mode)," and Figure 3, "Si5326 Typical Application Circuit (SPI Control Mode)," on page 5 to show preferred external reference interface.
- Updated "2. Pin Descriptions: Si5326".
  - Added RATE0 and changed RATE to RATE1 and expanded RATE[1:0] description.
  - Changed font of register names to *underlined italics*.
- Updated "3. Ordering Guide" on page 11.
- Added "4. Package Outline: 36-Pin QFN" on page 12.
- Added "5. Recommended PCB Layout".



## Si5326

### **CONTACT INFORMATION**

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